

Vishay Siliconix

## P-Channel 20 V (D-S) MOSFET



PRODUCT SUMMARY				
V <sub>DS</sub> (V)	-20			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -4.5 \text{ V}$	0.0140			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -2.5 V	0.0200			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -1.8 \text{ V}$	0.0300			
Q <sub>g</sub> typ. (nC)	39			
I <sub>D</sub> (A)	-15.4 <sup>e</sup>			
Configuration	Single			

#### **FEATURES**

- TrenchFET® Gen III p-channel power MOSFET
- 1.8 V rated R<sub>DS(on)</sub>
- 100% R<sub>q</sub> tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

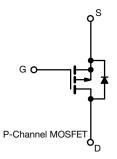


RoHS COMPLIANT

HALOGEN FREE

#### **APPLICATIONS**

- Adapter switch
- · Load switch
- DC/DC converters
- · High speed switching
- Power management in battery-operated, mobile and wearable devices



ORDERING INFORMATION					
Package	SO-8				
Lead (Pb)-free and halogen-free Si4403DDY-T1-GE3					
<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_A = 25$ °C, unless otherwise noted)					

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	-20	V
Gate-source voltage		$V_{GS}$	± 8	7 °
	T <sub>C</sub> = 25 °C		-15.4 <sup>e</sup>	
Continuous dusin surrent /T 150 °C\	T <sub>C</sub> = 70 °C	Ι.	-12.3	7
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> =25 °C	I <sub>D</sub>	-10.9 <sup>b, c</sup>	7
	T <sub>A</sub> = 70 °C	İ	-8.7 <sup>b, c</sup>	Α
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	-32 <sup>a</sup>	7
	T <sub>C</sub> = 25 °C	Is	-4.2	7
Continuous source-drain diode current	T <sub>A</sub> = 70 °C		-2 b, c	7
	T <sub>C</sub> = 25 °C	P <sub>D</sub>	5	
Maximum power dissipation	T <sub>C</sub> = 70 °C		3.2	
	T <sub>A</sub> = 25 °C		2.4 b, c	W
	T <sub>A</sub> = 70 °C		1.5 <sup>b, c</sup>	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Soldering recommendations (peak temperature)			260	7 °C

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT			
Maximum junction-to-ambient b, d	t ≤ 10 s	R <sub>thJA</sub>	41	52	°C/W		
Maximum junction-to-foot (drain)	Steady state	R <sub>thJF</sub>	20	25	C/VV		

#### Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. Maximum under steady state conditions is 100 °C/W
- e.  $T_C = 25$  °C

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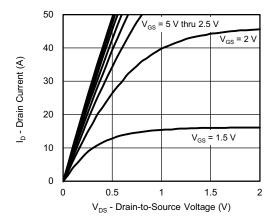
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•			·	
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-20	-	-	٧	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	-12.5	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	ΔV <sub>GS(th)</sub> /T <sub>J</sub>	I <sub>D</sub> = -250 μA	-	26.5	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-0.4	-	-1	٧	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	-	-	± 100	nA	
Zana alian alla andre la const		V <sub>DS</sub> = -20 V, V <sub>GS</sub> = 0 V		-	-1	_	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	-10	μA	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = 0 \text{ V}$	-5	-	-	Α	
	, ,	$V_{GS} = -4.5 \text{ V}, I_D = -9 \text{ A}$	-	0.0105	0.0140		
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -2.5 \text{ V}, I_D = -6 \text{ A}$	-	0.0140	0.0200	Ω	
		$V_{GS} = -1.8 \text{ V}, I_D = -3 \text{ A}$	-	0.0190	0.0300		
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -9 A	-	45	-	S	
Dynamic <sup>b</sup>			•				
Input capacitance	C <sub>iss</sub>		-	3250	-		
Output capacitance	Coss	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	340	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>		-	325	-		
Total gate charge	Q <sub>g</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = -8 \text{ V}, I_D = -5 \text{ A}$	-	66	99	1	
		$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -5 \text{ A}$	-	39	59	1	
Gate-source charge	Q <sub>gs</sub>	V 40VV 45V1 54	-	3.7	-	nC	
Gate-drain charge	Q <sub>qd</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -5 \text{ A}$	-	7.9	-		
Gate resistance	Rg	f = 1 MHz	0.7	3.7	7.4	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	21	40		
Rise time	t <sub>r</sub>	$V_{DD} = -10 \text{ V}, R_L = 2 \Omega, I_D \cong -5 \text{ A},$	-	25	50		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	-	70	140		
Fall time	t <sub>f</sub>		-	24	50		
Turn-on delay time	t <sub>d(on)</sub>		-	9	20	ns	
Rise time	t <sub>r</sub>	$V_{DD} = -10 \text{ V}, R_1 = 2 \Omega, I_D \cong -5 \text{ A},$	-	18	35	1	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = -8 \text{ V}, R_g = 1 \Omega$	-	74	150		
Fall time	t <sub>f</sub>		-	20	40	1	
<b>Drain-Source Body Diode Characteristi</b>	cs		•	1			
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	-5.2	,	
Pulse diode forward current	I <sub>SM</sub>		-	-	-32	A	
Body diode voltage	V <sub>SD</sub>	$I_S = -5 \text{ A}, V_{GS} = 0 \text{ V}$	-	-0.8	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	31	60	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>		-	20	40	nC	
Reverse recovery fall time	ta	$I_F = -5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$	_	12	-		
Reverse recovery rise time	t <sub>b</sub>			19	_	ns	

### Notes

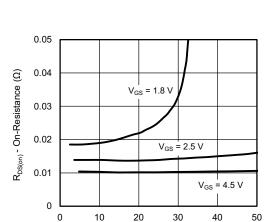
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



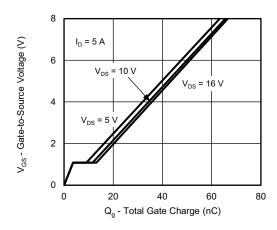


### **Output Characteristics**

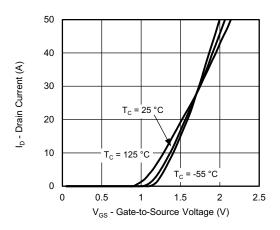


On-Resistance vs. Drain Current and Gate Voltage

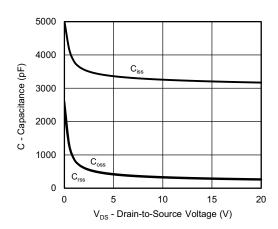
I<sub>D</sub> - Drain Current (A)



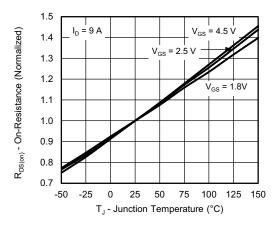
**Gate Charge** 



**Transfer Characteristics** 

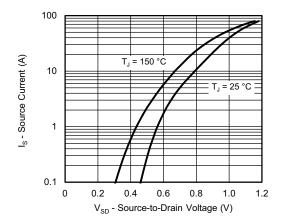


Capacitance

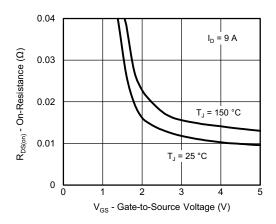


On-Resistance vs. Junction Temperature

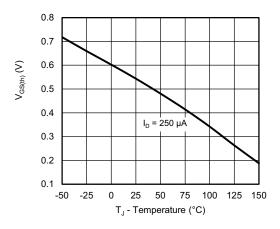




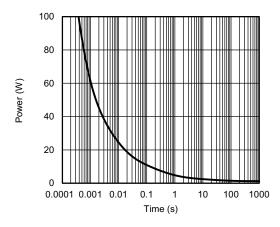
Source-Drain Diode Forward Voltage



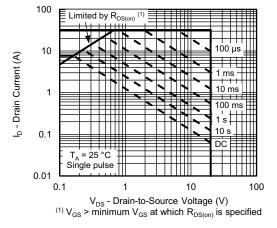
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 

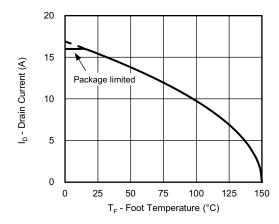


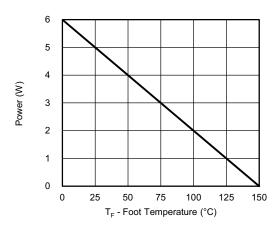
Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient





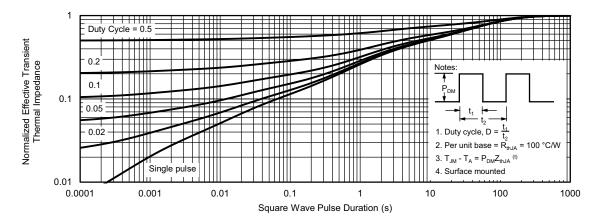


Current Derating <sup>a</sup> Power, Junction-to-Foot

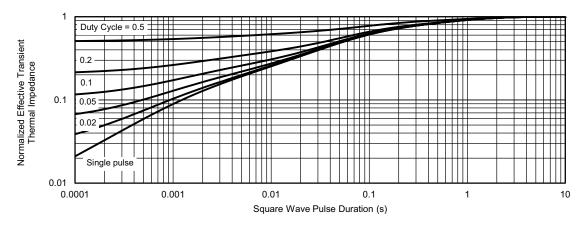
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



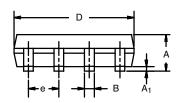
Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?70094">www.vishay.com/ppg?70094</a>.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	TERS INCHES		
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
FCN: C-06527-Bey   11-Sen-06					

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498

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### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

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